

# **SPECIFICATION**

Product Name

MEMS OSCILLATOR

Туре

MO1532

Nominal Frequency

32.768kHz

Spec No.

1JAAL0032768AACX

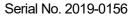
If there is a change in this specifications, the specification number may be changed.

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http://www.kds.info/index\_en.htm

C.ENG.	1. Hanaki
ENG.	T. Moriwaki





DATE: 2019.03.13

ITEM:	MEMS OSCILLATOR
PRODUCT TYPE:	MO1532IL4-DCCM-YY-0032768D
NOMINAL FREQUENCY:	32.768kHz
Size:	1.5 x 0.8 mm

Spec No.:

1JAAL0032768AACX

Pb Free Products

Specification

ltem	Ordering Code	Specification
Operation Temp.		-40 to +85°C
Size	L4	1.5 x 0.8 x 0.60Max. CSP 4Pads
Output 1	D	DC-Coupled
Output 2	С	Rail to Rail LVCMOS
Output 3	С	Rail to Rail LVCMOS
Freq. Deviation	М	100 ppm or ±100 ppm
Vdd	YY	Any Voltage 1.62 to 3.63V
Packing	D	8mm Tape & Reel, 3ku reel



### Features

- Smallest footprint in chip-scale (CSP): 1.5 x 0.8 mm
- Fixed 32.768 kHz
- <+10 ppm frequency tolerance</p>
- Ultra-low power: <+1 µA
- Directly interfaces to XTAL inputs
- Supports coin-cell or super-cap battery backup voltages
- Vdd supply range: +1.5V to +3.63V over -40°C to +85°C
- Oscillator output eliminates external load caps
- Internal filtering eliminates external Vdd bypass cap
- NanoDrive<sup>™</sup> programmable output swing for lowest power
- Pb-free, RoHS and REACH compliant

#### **Applications**

- Mobile Phones
- Tablets
- Health and Wellness Monitors
- Fitness Watches
- Sport Video Cams
- Wireless Keypads
- Ultra-Small Notebook PC
- Pulse-per-Second (pps) Timekeeping
- RTC Reference Clock
- Battery Management Timekeeping

## **Electrical Specifications**

### **Table 1. Electrical Characteristics**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
			Free	quency and	Stability	
Fixed Output Frequency	Fout		32.768		kHz	
			Fi	requency St	ability	
		-	-	10	ppm	$T_A$ = +25°C, post reflow, Vdd: +1.5V - +3.63V.
Frequency Tolerance <sup>[1]</sup>	F_tol	-	-	20	ppm	$T_A$ = +25°C, post reflow with board-level underfill, Vdd: +1.5V - +3.63V.
		-	-	75		$T_A = -10^{\circ}C$ to +70°C, Vdd: +1.5V - +3.63V.
Frequency Stability <sup>[2]</sup>	F_stab	-	-	100	ppm	$T_A = -40^{\circ}C$ to +85°C, Vdd: +1.5V - +3.63V.
		-	-	250		$T_A = -10^{\circ}C$ to +70°C, Vdd: +1.2V - +1.5V.
25°C Aging		-1.0	-	+1.0	ppm	1st Year
		S	upply Volta	ge and Curr	ent Consun	nption
Operating Supply Voltage	Vdd	+1.2	-	+3.63	V	$T_A = -10^{\circ}C \text{ to } +70^{\circ}C$
Operating Suppry Voltage	vuu	+1.5	-	+3.63	v	$T_A = -40^{\circ}C$ to $+85^{\circ}C$
		-	+0.90	-		T <sub>A</sub> = +25°C, Vdd: +1.8V. No load
Core Operating Current <sup>[3]</sup>	ldd	-	-	+1.3	μA	$T_A = -10^{\circ}C$ to +70°C, Vdd max: +3.63V. No load
		-	-	+1.4		T <sub>A</sub> = -40°C to +85°C, Vdd max: +3.63V. No load
Output Stage Operating Current <sup>[3]</sup>	ldd_out	-	+0.065	+0.125	µA/Vpp	$T_A = -40^{\circ}C$ to +85°C, Vdd: +1.5V - +3.63V. No load
Power-Supply Ramp	t_Vdd_ Ramp	-	-	100	ms	Vdd Ramp-up from 0 to 90%, $T_A = -40^{\circ}C$ to +85°C
Quart 7	t stort	-	180	300		$T_A = -40^{\circ}C \le T_A \le +50^{\circ}C$ , valid output
Start-up Time at Power-up <sup>[4]</sup>	t_start	-	-	450	ms	$T_A = +50^{\circ}C < T_A \le +85^{\circ}C$ , valid output
			Operat	ing Temper	atureRange	)
Commercial Temperature	Tues	-10	-	+70	°C	
Industrial Temperature	T_use	-40	-	+85	°C	

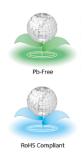
#### Notes:

1. Measured peak-to-peak. Tested with Agilent 53132A frequency counter. Due to the low operating frequency, the gate time must be ≥100 ms to ensure an accurate frequency measurement.

 Measured peak-to-peak. Inclusive of Initial Tolerance at +25°C, and variations over operating temperature, rated power supply voltage and load. Stability is specified for two operating voltage ranges. Stability progressively degrades with supply voltage below +1.5V.

Core operating current does not include output driver operating current or load current. To derive total operating current (no load), add core operating current + (+0.065 μA/V)\* (output voltage swing).
 Macourad from the time Vdd reaches 14.5V

4. Measured from the time Vdd reaches +1.5V.





### Table 1. Electrical Characteristics (continued)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
	LVCMC	OS Output	Option, T <sub>A</sub> = -	40°C to +8	5°C, typical	values are at T <sub>A</sub> =25°C
Output Rise/Fall Time	tr. tf	-	100	200	ns	10-90% (Vdd), 15 pF load, Vdd = +1.5V to+3.63V
	u, u	Ι	-	50	115	10-90% (Vdd), 5.0 pF load, Vdd ≥+1.62V
Output Clock Duty Cycle	DC	48	-	52	%	
Output Voltage High	Vон	90%	-	-	V	Vdd: +1.5V - +3.63V. I <sub>OH</sub> = -10 µA, 15 pF
Output Voltage Low	Vol	-	-	10%	V	Vdd: +1.5V - +3.63V. I <sub>OL</sub> = +10 µA, 15 pF
		Nanol	Orive™ Progr	ammable,	Reduced Sv	wing Output
Output Rise/Fall Time	tf, tf	-	-	200	ns	30-70% (V <sub>OL</sub> /V <sub>OH</sub> ), 10 pF Load
Output Clock Duty Cycle	DC	48	-	52	%	
AC-coupled Programmable Output Swing	V_sw	-	+0.20 to +0.80	-	v	MO1532 does not internally AC-couple. This output description is intended for a receiver that is AC-coupled. See Table 2 for acceptable NanoDrive swing options. Vdd: +1.5V - +3.63V, 10 pF Load, $I_{OH} / I_{OL} = \pm 0.2 \ \mu$ A.
DC-Biased Programmable Output Voltage High Range	Vон	-	+0.60 to +1.225	-	V	Vdd: +1.5V – +3.63V. $I_{OH}$ = -0.2 $\mu A,$ 10 pF Load. See Table 1 for acceptable $V_{OH}/V_{OL}$ setting levels.
DC-Biased Programmable Output Voltage Low Range	Vol	-	+0.35 to +0.80	-	V	Vdd: +1.5V – +3.63V. $I_{OL}$ = +0.2 $\mu$ A, 10 pF Load. See Table 1 for acceptable V <sub>OH</sub> /V <sub>OL</sub> setting levels.
Programmable Output Voltage Swing Tolerance		-0.055	-	+0.055	V	$T_A = -40^{\circ}C$ to $+85^{\circ}C$ , Vdd $= +1.5V$ to $+3.63V$ .
				Jitter		
Period Jitter	T_jitt	-	35	-	ns <sub>RMS</sub>	Cycles = 10,000, T <sub>A</sub> = +25°C, Vdd = +1.5V - +3.63V

### **Table 2. Pin Configuration**

Pin	Symbol	I/O	Functionality	
1, 4	GND	Power Supply Ground	Connect to ground. Acceptable to connect pin 1 and 4 together. Both pins must be connected to GND.	CSP Package (Top View)
2	CLK Out	OUT	Oscillator clock output. The CLK can drive into a Ref CLK input or into an ASIC or chip-set's 32kHz XTAL input. When driving into an ASIC or chip-set oscillator input (X IN and X Out), the CLK Out is typically connected directly to the XTAL IN pin. No need forload capacitors. The output driver is intended to be insensitive to capacitive loading.	GND 1 4 GND
3	Vdd	Power Supply	Connect to power supply +1.2V $\leq$ Vdd $\leq$ +3.63V. Under normal operating conditions, Vdd does not require external bypass/decoupling capacitor(s). For more information about the internal power-supply filtering, see the <i>Power Supply Noise Immunity</i> section in the detailed description. Contact factory for applications that require a wider operating supply voltage range.	CLK Out 2 3 Vdd Figure 1. Pin Assignments



## System Block Diagram

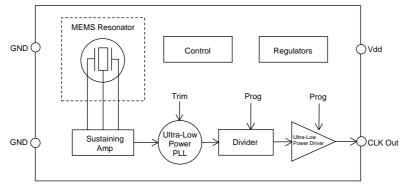


Figure 2. MO1532 Block Diagram

#### Table 3. Absolute Maximum

Attempted operation outside the absolute maximum ratings may cause permanent damage to the part. Actual performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

Parameter	Test Condition	Value	Unit
Continuous Power Supply Voltage Range (Vdd)		-0.5 to +3.63	V
Short Duration Maximum Power Supply Voltage (Vdd)	<30 minutes	+4.0	V
Continuous Maximum Operating Temperature Range	Vdd = +1.5V - +3.63V	+105	°C
Short Duration Maximum Operating Temperature Range	Vdd = +1.5V - +3.63V, ≤30 mins	+125	°C
Human Body Model ESD Protection	JESD22-A114	+3000	V
Charge-Device Model (CDM) ESD Protection	JESD22-C101	+750	V
Machine Model (MM) ESD Protection	JESD22-A115	+300	V
Latch-up Tolerance	JESD78 (	Compliant	
Mechanical Shock Resistance	Mil 883, Method 2002	10,000	g
Mechanical Vibration Resistance	Mil 883, Method 2007	70	g
1508 CSP Junction Temperature		+150	°C



## Description

The MO1532 is the world's smallest, lowest power 32 kHz oscillator optimized for mobile and other battery-powered applications. KDS's silicon MEMS technology enables the smallest footprint and chip-scale packaging. This device reduces the 32 kHz footprint by as much as 85% compared to existing 2.0 x 1.2 mm SMD XTAL packages. Unlike XTALs, the MO1532 oscillator output enables greater component placement flexibility and eliminates external load capacitors, thus saving additional component count and board space. And unlike standard oscillators, the MO1532 features NanoDrive™, a factory programmable output that reduces the voltage swing to minimize power.

The +1.2V to +3.63V operating supply voltage range makes it an ideal solution for mobile applications that incorporate a low-voltage, battery-back-up source such as a coin-cell or super-cap.

KDS's MEMS oscillators consist of MEMS resonators and a programmable analog circuit. Our MEMS resonators are built with unique MEMS process. A key manufacturing step is Epi-Seal during which the MEMS resonator is annealed with temperatures over +1000°C. Epi-Seal creates an extremely strong, clean, vacuum chamber that encapsulates the MEMS resonator and ensures the best performance and reliability. During Epi-Seal, a poly silicon cap is grown on top of the resonator cavity, which eliminates the need for additional cap wafers or other exotic packaging. As a result, KDS's MEMS resonator die can be used like any other semiconductor die. One unique result of KDS's MEMS process and Epi-Seal manufacturing processes is the capability to integrate KDS's MEMS die with a SOC, ASIC, microprocessor or analog die within a package to eliminate external timing components and provide a highly integrated, smaller, cheaper solution to the customer.

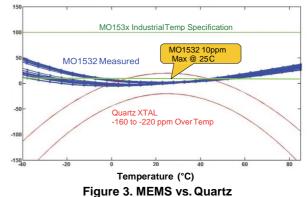
#### **Frequency Stability**

The MO1532 is factory calibrated (trimmed) to guarantee frequency stability to be less than 10 ppm at room temperature and less than 100 ppm over the full -40°C to +85°C temperature range. Unlike quartz crystals that have a classic tuning fork parabola temperature curve with a +25°C turnover point, the MO1532 temperature coefficient is extremely flat across temperature. The device maintains less than 100 ppm frequency stability over the full operating temperature range when the operating voltage is between +1.5 and +3.63V as shown in Figure 2.

Functionality is guaranteed over the +1.2V - +3.63V operating supply voltage range. However, frequency stability degrades below +1.5V and steadily degrades as it approaches the +1.2V minimum supply due to the internal regulator limitations. Between +1.2V and +1.5V, the frequency stability is 250 ppm max over temperature.

When measuring the MO1532 output frequency with a frequency counter, it is important to make sure the counter's gate time is  $\geq$ 100ms. The slow frequency of a 32kHz clock will give false readings with faster gate times.

Contact KDS for applications that require a wider supply voltage range >+3.63V or lower frequency options as low as 1Hz.



### **Power Supply Noise Immunity**

In addition to eliminating external output load capacitors common with standard XTALs, The MO1532 includes special internal power supply filtering and thus, eliminates the need for an external Vdd bypass-decoupling capacitor. This feature further simplifies the design and keeps the footprint as small as possible. Internal power supply filtering is designed to reject greater than  $\pm 150$  mVpp magnitude and frequency components through 10 MHz.

#### Output Voltage

The MO1532 has two output voltage options. One option is a standard LVCMOS output swing. The second option is the NanoDrive reduced swing output. Output swing is customer specific and programmed between +200mV and +800mV. For DC-coupled applications, output  $V_{OH}$  and  $V_{OL}$  are individually factory programmed to the customers' requirement. VOH programming range is between +600 mV and +1.225V in +100 mV increments. Similarly, V<sub>OI</sub> programming range is between +350mV and +800mV. For example; a PMIC or MCU is internally +1.8V logic compatible, and requires a +1.2V VIH and a +0.6V VIL. Simply select MO1532 NanoDrive factory programming code to be "D14" and the correct output thresholds will match the downstream PMIC or MCU input requirements. Interface logic will vary by manufacturer and we recommend that you review the input voltage requirements for the input interface.

For DC-biased NanoDrive output configuration, the minimum  $V_{OL}$  is limited to +350mV and the maximum allowable swing  $(V_{OH} - V_{OL})$  is +750 mV. For example, +1.1V  $V_{OH}$  and +400 mV  $V_{OL}$  is acceptable, but +1.2V  $V_{OH}$  and +400 mV  $V_{OL}$  is not acceptable.

When the output is interfacing to an XTAL input that is internally AC-coupled, the MO1532 output can be factory programmed to match the input swing requirements. For example, if a PMIC or MCU input is internally AC-coupled and requires an +800 mV swing, then simply choose the MO1532 NanoDrive programming code "AA8" in the part number. It is important to note that the MO1532 does not include internal AC-coupling capacitors. Please see the *Part Number Ordering* section at the end of the datasheet for more information about the part number ordering scheme.



#### Power-up

The MO1532 starts-up to a valid output frequency within 300 ms (180 ms typ). To ensure the device starts-up within the specified limit, make sure the power-supply ramps-up in approximately 10 - 20 ms (to within 90% of Vdd). Start-up time is measured from the time Vdd reaches +1.5V. For applications that operate between +1.2V and +1.5V, the start-up time will be typically 50 ms longer over temperature.

### MO1532 NanoDrive™

Figure 3 shows a typical output waveform of the MO1532 (into a 10 pF load) when factory programmed for a +0.70V swing and DC bias (V<sub>OH</sub>/V<sub>OL</sub>) for +1.8V logic:

#### Example:

- NanoDrive<sup>™</sup> part number coding: D14. Example part number: MO1532IL4-<u>D14</u>M-YY-0032768S
- V<sub>OH</sub> = 1.1V, V<sub>OL</sub> = +0.4V (V<sub>\_sw</sub> = +0.70V)

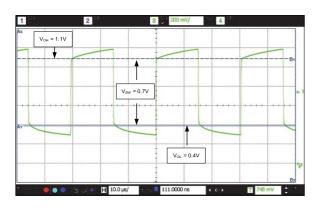


Figure 4. MO1532IL4-D14M-YY-0032768 Output Waveform (10 pF load)

Table 1 shows the supported NanoDrive  $^{\rm TM}$  V\_OH, V\_OL factory programming options.

Table 4. Acceptable V<sub>OH</sub>/V<sub>OL</sub> NanoDrive<sup>™</sup> Levels

NanoDrive	V <sub>он</sub> (V)	V <sub>0L</sub> (V)	Swing (mV)	Comments
D26	+1.2	+0.6	+600 ±55	+1.8V logic compatible
D14	+1.1	+0.4	+700 ±55	+1.8V logic compatible
D74	+0.7	+0.4	+300 ±55	XTAL compatible
AA3	n/a	n/a	+300 ±55	XTAL compatible

The values listed in Table 1 are nominal values at  $+25^{\circ}$ C and will exhibit a tolerance of  $\pm 55 \text{ mV}$  across Vdd and  $-40^{\circ}$ C to  $+85^{\circ}$ C operating temperature range.

## MO1532 Full Swing LVCMOS Output

The MO1532 can be factory programmed to generate full swing LVCMOS levels. Figure 4 shows the typical waveform (Vdd = +1.8V) at room temperature into a 15 pF load.

#### Example:

- LVCMOS output part number coding is always DCC
- Example part number: MO1532IL4-DCCM-YY-0032768

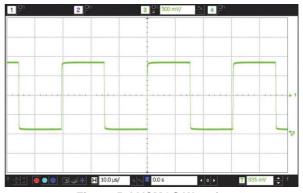


Figure 5. LVCMOS Waveform (Vdd = +1.8V) into 15 pF Load



## **Calculating Load Current**

#### No Load Supply Current

When calculating no-load power for the MO1532, the core and output driver components need to be added. Since the output voltage swing can be programmed for reduced swing between +250 mV and +800 mV for ultra-low power applications, the output driver current is variable. Therefore, no-load operating supply current is broken into two sections; core and output driver. The equation is as follows:

Total Supply Current (no load) = I<sub>dd</sub> Core + (65nA/V)(Vout<sub>pp</sub>)

#### Example 1: Full-swing LVCMOS

- Vdd = +1.8V
- Idd Core = +900nA (typ)
- Vout<sub>pp</sub> = +1.8V

Supply Current = 900nA + (65nA/V)(1.8V) = +1017nA

#### Example 2: NanoDrive™ Reduced Swing

- Vdd = +1.8V
- Idd Core = +900nA (typ)
- Vout<sub>pp</sub> (D14) =  $V_{OH} V_{OL} = 1.1V 0.4V = +700mV$  Supply
- Supply Current = 900nA + (65nA/V)(0.7V) =+946nA

#### Total Supply Current with Load

To calculate the total supply current, including the load, follow the equation listed below. Note the 30% reduction in power with NanoDrive<sup>TM</sup>.

Total Current = Idd Core + Idd Output Driver (65nA/V\*Vout<sub>pp</sub>) + Load Current (C\*V\*F)

#### Example 1: Full-swing LVCMOS

- Vdd = +1.8V
- Idd Core = +900nA
- Load Capacitance = 10pF
- Idd Output Driver: (65nA/V)(1.8V) = +117nA
- Load Current: (10pF)(1.8V)(32.768kHz) = +590nA
- Total Current = 900nA + 117nA + 590nA = +1.6µA

#### <u>Example 2</u>: NanoDrive™ Reduced Swing

- Vdd = +1.8V
- Idd Core = +900nA
- Load Capacitance = 10pF
- Vout<sub>pp</sub> (Programmable):  $V_{OH} V_{OL} = 1.1V 0.4V = +700mV$
- Idd Output Driver: (65nA/V)(0.7V) =+46nA
- Load Current: (10pF)(0.7V)(32.768kHz) = +229nA
- Total Current = 900nA + 46nA + 229nA = +1.175µA

## **MO1532** Smallest Footprint (1.2mm<sup>2</sup>) CSP, 10 ppm Ultra-Low Power 32.768 kHz XTAL Replacement



## **Typical Operating Curves**

(T<sub>A</sub> = +25°C, Vdd = +1.8V, unless otherwise stated)

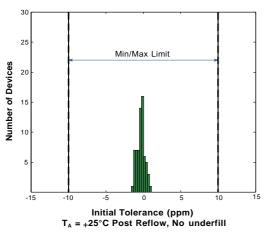


Figure 6. Initial Tolerance Histogram

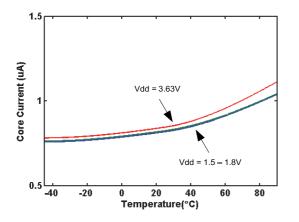
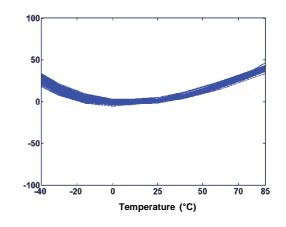
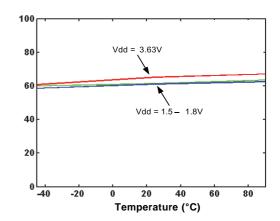


Figure 8. Core Current Over Temperature









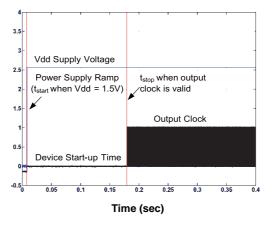
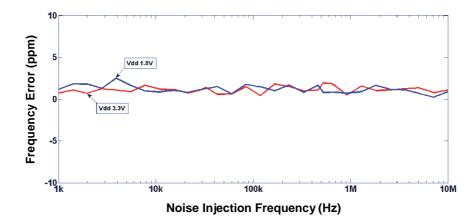
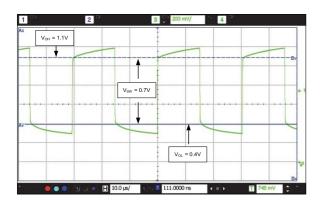


Figure 10. Start-up Time









**Figure 12. NanoDrive™ Output Waveform** (V<sub>OH</sub> = +1.1V, V<sub>OL</sub> = +0.4V, MO1532IL4-D14M-YY-0032768S)

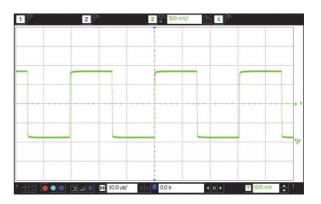
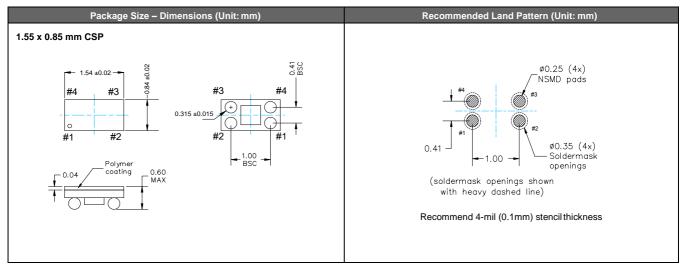


Figure 13. LVCMOS Output Waveform (V<sub>swing</sub> = +1.8V, MO1532IL4-DCCM-YY-0032768S)



## **Dimensions and Patterns**



## Manufacturing Guidelines

1) No Ultrasonic Cleaning: Do not subject the MO1532 to an ultrasonic cleaning environment. Permanent damage or long term reliability issues to the MEMS structure may occur.

2) Applying board-level underfill (BLUF) to the device is acceptable, but will cause a shift in the frequency tolerance, as specified in the datasheet electrical table. Tested with UF3810, UF3808, and FP4530 underfill.

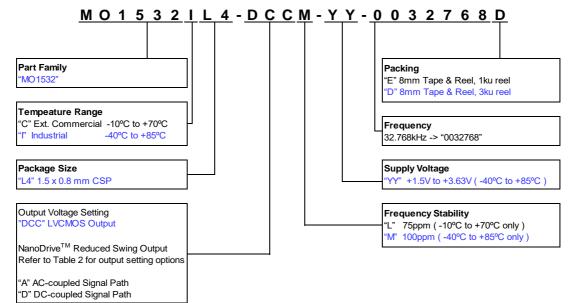
3) Reflow profile, perJESD22-A113D.

4) For additional manufacturing guidelines and marking/tape-reel instructions, contact KDS.

## **MO1532** Smallest Footprint (1.2mm<sup>2</sup>) CSP, 10 ppm Ultra-Low Power 32.768 kHz XTAL Replacement



### **Ordering Information**



The following examples illustrate how to select the appropriate temp range and output voltage requirements:

#### Example 1: MO1532IL4-D14M-YY-0032768

- Industrial temp & corresponding 100 ppm frequency stability. Note, 100 ppm is only available for the industrial temp range, and 75 ppm is only available for the commercial temp range.
- Output swing requirements:
  - a) "D" = DC-coupled receiver
  - b) "1" = V<sub>OH</sub> = +1.1V
  - c) "4" = V<sub>OL</sub> = +400mV

#### Example 2: MO1532CL4-AA3L-YY-0032768

- Commercial temp & corresponding 75 ppm frequency stability. Note, 100 ppm is only available for the industrial temp range, and 75 ppm is only available for the commercial temp range.
- Output swing requirements:
  - a) "A" = AC-coupled receiver
  - b) "A" = AC-coupled receiver
  - c) "3" = +300mV swing

# Table 2. Acceptable V<sub>OH</sub>/V<sub>OL</sub> NanoDrive<sup>™</sup> Levels<sup>[5]</sup> NanoDrive

NanoDrive	V <sub>он</sub> (V)	V <sub>0L</sub> (V)	Swing (mV)	Comments
D26	+1.2	+0.6	+600 ±55	+1.8V logic compatible
D14	+1.1	+0.4	+700 ±55	+1.8V logic compatible
D74	+0.7	+0.4	+300 ±55	XTAL compatible
AA3	n/a	n/a	+300 ±55	XTAL compatible

Notes:

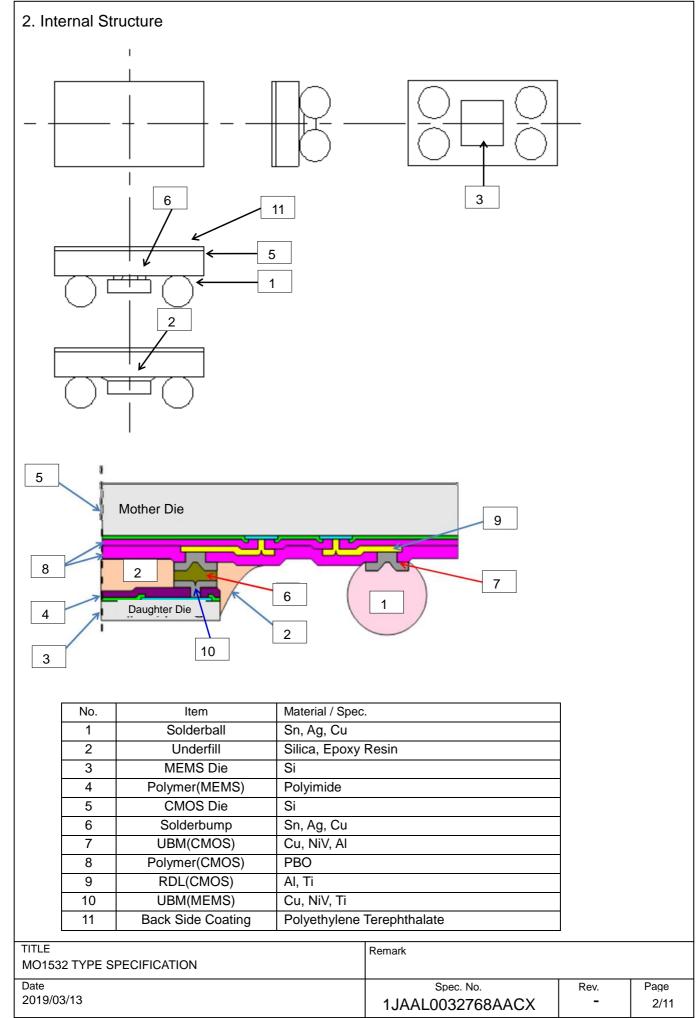
5. If these available options do not accommodate your application, contact KDS for other NanoDrive options.



## **Revision History**

Version	Release Date	Change Summary
1.0	09/02/14	<ul> <li>Rev 0.9 Preliminary to Rev 1.0 Production Release</li> <li>Updated start-up time specification</li> <li>Added typical operating plots</li> <li>Separated initial tolerance spec for condition with and without underfill</li> <li>Added Manufacturing Guidelines section</li> </ul>
1.1	10/14/14	<ul> <li>Improved Start-up Time at Power-up spec</li> <li>Added 5pF LVCMOS rise/fall time spec</li> </ul>
1.2	11/07/14	Updated 5pF LVCMOS rise/fall time spec
1.25	06/03/16	<ul> <li>Updated NanoDrive section</li> <li>Updated test conditions in the absolute maximum table</li> </ul>
1.26	01/16/2018	Updated SPL, page layout changes

/	Assembly Identifier		
Y X • X X X	Manufacturing Lot Code		
#1 Index			
"Y" denotes assembly "A": Carsem / Mala "B": UTAC / Thailar "C": ASE / Taiwan	ysia		
	na-numeric characters of the manufacturing lot code without	any dashes	5,
Periods, or symbols.			
532 TYPE SPECIFICATION	Remark		



## 3. Solder Reflow Profile 3.1 Solder Reflow Profile The solder reflow profile shown in the following is IPC/JEDEC J-STD-020 compliant. ■Reflow Temperature Profile (Available for lead free soldering) **Critical Zone** TL to Tp Тр Ramp-Up Ramp-Down T<sub>L</sub> Temperature (T) TS MAX T<sub>S</sub> MIN ts Preheat . 4 t<sub>i</sub> t 25°C to Peak

Time (t)

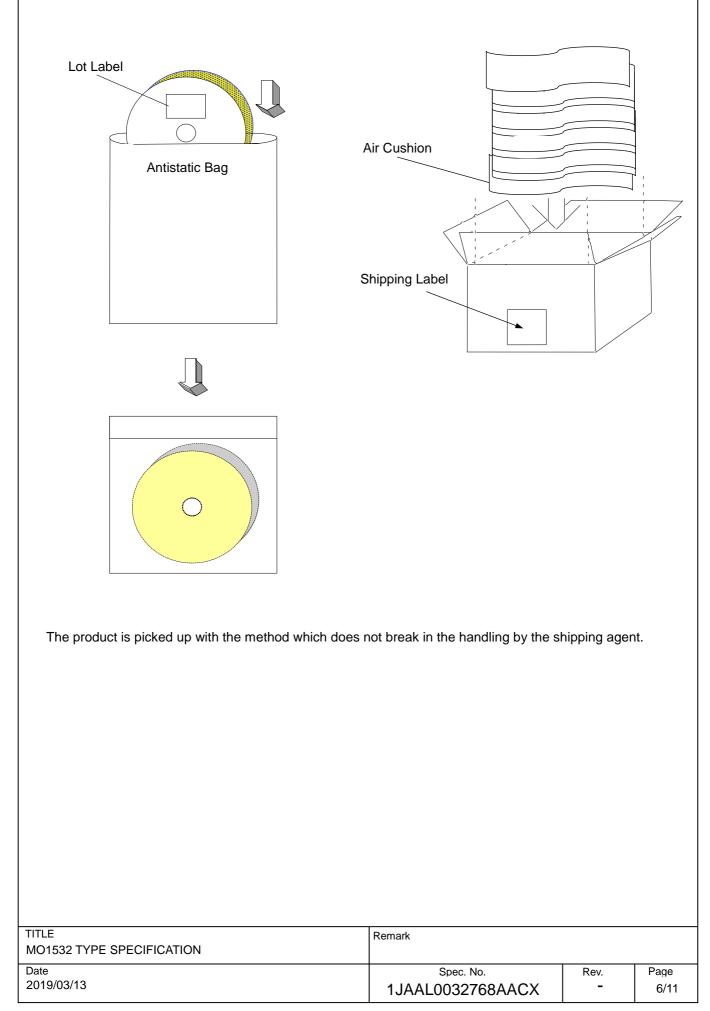
#### ■High Temperature Infrared/Convection Reflow Conditions IPC/JEDEC J-STD-020

IPC/JEDEC Standard	IPC/JEDEC J-STD-020
Moisture Sensitivity Level	Level 1
TS MAX to TL (Ramp-up Rate)	3°C/second Maximum
Preheat	
- Temperature Minimum (TS MIN)	+150°C
- Temperature Typical (TS TYP)	+175°C
- Temperature Maximum (TS MAX)	+200°C
- Time (tS)	60 - 180 Seconds
Ramp-up Rate (TL to TP)	3°C/second Maximum
Time Maintained Above:	
- Temperature(TL)	+217°C
- Time (TL)	60 - 150 Seconds
Peak Temperature(TP)	+260°C Maximum
Target Peak Temperature (TP Target)	+255°C
Time within 5°C of actual peak (tP)	20 - 40 seconds
Max. Number of Reflow Cycles	3
Ramp-down Rate	6°C/second Maximum
Time 25°C to Peak Temperature (t)	8 minutes Maximum

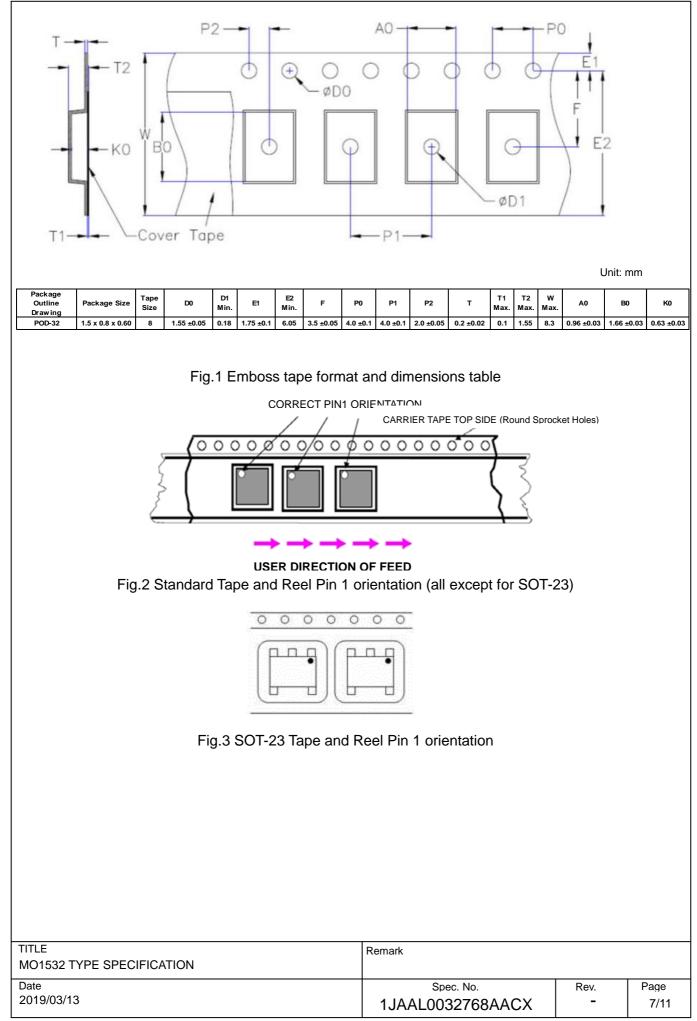
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						Serial I	No.2019-0156
I. Pack	king Condition						
	ing package						
-		nat, dimensions and	direction				
	See Fig.1, Fig.2,	Fig.3					
(2)	) Quantity on reel						
	See suffix of part						
(3)	) Taping specification	on					
	See Fig.4						
(4)	) Reel specification						
	See suffix of part	-	, he different in t		ant abin manta dan an	line on month	turin -
	-	, the specifications of			ent shipments depend	ang on manun	acturing
(5	) Taping material li	-	the reel are lue		matarial List		
(-	See right table.				<u>material List</u> Tape : PS(Antistatic)		
					s : PS (Conductivity)		
(6)	) Packing specifica	tion list			PS (Antistatic)		
	See Table.1	1			TO (Antistatic)		
	Taping	Emboss	Package S	ize	Reel Size	Quantity	
	Part code	Taping	(mm)		(mm Max.)	(pcs)	
	D	8mm width	1.5 x 0.8	3	180	3000	
Та	able.1 Packing sp	pecification of part of	ode				
*	The detail of part of	code was mentioned	in data sheet.				
1.2 Pac	sking						
The	products packed i	n the antistatic bag.					
		vel : IPC/JEDEC Sta	ndard J-STD-03	3 / Level	1		
	-	and baking after re-s					
		-	-	-			
4.3 Pac	king box						
			case of less thai	10 reels	s, It is contained by ar	ny boxes.	
The	space in a box is f	fill up with a cushion.					
41.040	الململم						
	el detail	reel and a shipping la	hal is put on a r	ooking b	0.1		
Lot la	-	reer and a shipping is		acking b	0.		
KD	OS (LOGO)			ESD, Pb·	-free(LOGO)		
	ΈE	(Model Name/Part	,				
	PEC NO.	(KDS Spec. Numb					
	RTS NO.	(User's Parts Num	,				
	FG. LOT NO. EQ.	(Manufacturing Lot (Nominal Frequend		ig Lot Nu	imber)		
Q'		(Quantity)	MADE IN XXX	(XX(Cou	ntry Origin)		
		(Quantity)					
Shipp	bing label						
	OS (LOGO)			SD, Pb-f	ree(LOGO)		
	PE	(Model Name/Par	,				
		(KDS Spec. Num					
	RTS NO.	(User's Parts Nur (Shipping Lot Nur	nnor)				
	IIP LOT NO.		,				
			,				
Q	IIP DATE	(Shipping Date)	nber)	′XXX(Co	untry Origin)		
	TY		,	XXX(Co	untry Origin)		
	ΓΥ	(Shipping Date) (Quantity)	nber)	XXXX(Col Remark	untry Origin)		
IO1532 <sup>-</sup>		(Shipping Date) (Quantity)	nber)				
IO1532 <sup>-</sup> ate	TY TYPE SPECIFICA	(Shipping Date) (Quantity)	nber)	Remark	Spec. No.	Rev.	Page
ITLE 101532 <sup>-</sup> Pate 019/03/1	TY TYPE SPECIFICA	(Shipping Date) (Quantity)	nber)	Remark			Page 4/11

Image: Non-state of the state of the st	Q
Formation of a lot number_         M       M       9101       00101         Product code       Country origin       year/month/day       Serial No.         The notation method of country origin         A : Taiwan       M:Malaysia       U: Thailand	
The notation method of a manufacture year, month, and day.(4digit alphanumeric character) $\underline{YMDD}$ (4digits)e.g.) $201\underline{9}/0\underline{1}/0\underline{1} \rightarrow \underline{9101}$ $\underline{Y}$ Year1digit (Last digit of year) $\underline{M}$ Month1digit alphanumeric symbol $\underline{DD}$ Day2digits numerical characters of day	
Month Jan. Feb. Mar. Apr. May Jun. Jul. Aug. Sep. Oct. Nov. Dec.	
Symbol         1         2         3         4         5         6         7         8         9         O         N         D	
The marks on the label are as follows. ROHS> $i = i = i = i = i = i = i = i = i = i =$	
TITLE Remark MO1532 TYPE SPECIFICATION	



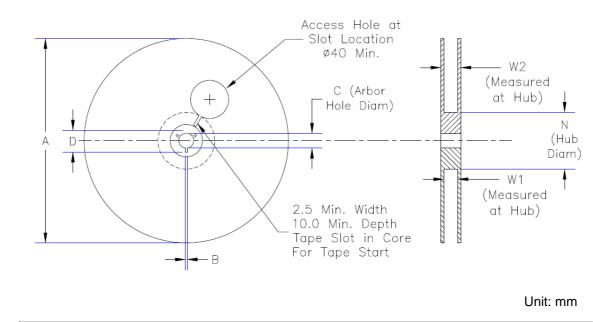
#### Serial No.2019-0156



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Trailer (160mm Min) Components	Leader (400mm Min)		
<u> </u>	<u> </u>		
	<u>○ ○ (\$) ○ ○</u> │	o Cover tape	
User Direction of Fee	d No Compor (150mm N		
((		over Tape	
	Enbossed Carrie	er	
Directionmark			
	ser Direction of Feed		
When a tape end is taken out to the front, sprock	set holes becomes right hand side	2	
Peel strength	ter noies becomes right hand side	·.	
Pulling speed at 300mm/min, strength should be	0.1~1.3N(10g~130g).		
Carrier tape basic dimensions are based on EIA	481.		
Fig.4. Taping specif	ication		
	Remark		
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Г



ape Size	A Max.	B Min.	С	D Min.	Ν	W1	W2 Max.
8	180	1.5	13.0 +0.6/-0.2	20	60 +0.5/-0.5	8.4 +1.5/-0	14.4

Fig.5	Reel format and dimensions
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### 5. Notes on mounting and handling

#### 5.1 Storage environment

- (1) The temperature and humidity of a storage place, Please give +5~+40°C and 40~85% as a standard.
- (2) Please use this product within one year from the packing label date of issue.
- (3) Please avoid the place which generates corrosive gas, and the place with much dirt.
- (4) Please keep it in a place with little temperature change.
- Dew condensation arises owing to a rapid temperature change and solderability becomes bad.
- 5.2 Be cautions to static electricity and high voltage.
- 5.3 This product has sufficient durability to fall and vibration. However, conditions may change to the fall after mounting to a PWB, and vibration. When you should drop on a floor the PWB which mounted the product or too much shock is added. Please use after a performance check.
- 5.4 Please check that the curvature of the substrate at the time of substrate cutting does not affect product. Moreover, especially when a product is near the position of a PWB guide pin, and the position of PWB break, be careful.
- 5.5 The part recommends not using cleaning baths operating at ultrasonic frequencies. Instead, KDS recommends that the customer use IPA (Isopropyl Alcohol) baths.
- 5.6 Please repair at +260°C in 5s with hot air.

#### 6. Mandatory control

6.1 Ozone-depleting substance

It regulates by the U.S. air purifying method (November, 1990 establishment). ODS of CLASS1 and CLASS2 is not contained or used.

### 6.2 PBDE, PBBs

PBDE, PBBs are not contained into all the material currently used for this product.

#### 6.3 RoHS

Following material restricted by RoHS (2011/65/EU) is not included or used. Lead, mercury, cadmium, hexavalent, chromium, PBB and PBDE.

6.4 Law Concerning Examination and Regulation of Manufacture, etc. of Chemical Substances

All the material currently used for this product is based on "Law Concerning Examination and Regulation of Manufacture, etc. of Chemical Substances". It is a registered material.

#### 6.5 Lead

Leads, such as solder, are not used for this product. (Lead Free)

6.6 About the existence of silver and mercury use

The silver and mercury are not used for this product.

7. The country origin (Manufacturing site and assembly, test location)

The country origin / Manufacture company

Taiwan / Advanced Semiconductor Engineering Inc.

Malaysia / Carsem Sdn. Bhd.

Thailand / UTAC Thai Ltd.

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## 2019-0156 REVERSION RECORD

Rev. No.	Date	Reason	Contents	Approved	Checked	Drawn
-	2019/03/13	-	Initial Release	T.Hanaki	T.Moriwaki	T.Moriwaki
				ļ		
				1		
				1		

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